

78 Series Regulators

Pb Free ROHM Electronic Components



1A Output 78 series Regulators 500mA Output 78 series Regulators

BA78□□Series,BA78M□□Series

No.12019ECT01

Description

Features

- 1) Built-in over-current protection circuit and thermal shutdown circuit
- 2) High ripple rejection
- 3) Available TO220CP-3, TO252-3 package to a wide range application
- 4) Compatible replacement to competitor products
- 5) Various voltage lineup (5V, 6V, 7V, 8V, 9V, 10V, 12V, 15V, 18V, 20V, 24V)

Applications

Fixed voltage power supply for TV, Audio components, etc

●Line up

■1A BA78□□Series

Part Number	5V	6V	7V	8V	9V	10V	12V	15V	18V	20V	24V	Package
ВА78□□СР	0	0	0	0	0	0	0	0	0	0	0	TO220CP-3
BA78□□FP	0	0	0	0	0	0	0	0	0	0	0	TO252-3

■0.5A BA78M□□Series

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Part Number	5V	6V	7V	8V	9V	10V	12V	15V	18V	20V	24V	Package
ВА78М□□СР	0	0	0	0	0	0	0	0	0	0	0	TO220CP-3
BA78M□□FP	0	0	0	0	0	0	0	0	0	0	0	TO252-3

Output Voltage and Marking

Symbol		assignment of	output	voltage			
		Output voltage(V)		Output voltage(V)			
	05	5.0V typ.	12	12V typ.			
	06			15V typ.			
а	07 7.0V typ.		18	18V typ.			
08		8.0V typ.	20	20V typ.			
	09	9.0V typ.	24	24V typ.			
	10	10.0V typ.					
		Package					
		CP : TO220C	P-3				
b	FP : TO252-3						

Symbol		assignment o	f outpu	ıt voltage				
		Output voltage(V)	Output voltage(V)					
	05	5.0V typ.	12	12V typ.				
	06	6.0V typ.	15	15V typ.				
а	07	7.0V typ.	18	18V typ.				
	08	8.0V typ.	20	20V typ.				
	09	9.0V typ.	24	24V typ.				
	10	10.0V typ.						
	ı	Package						
		CP : TO220CP-3						
b	FP: TO252-3							

● Absolute Maximum Rating (Ta=25°C)

BA78 CP/FP, BA78M CP/FP

Para	meter	Symbol	Limits	Unit
Power supply voltage		Vin	35	V
Power Dissipation 1	TO220CP-3	Pd1	2 *1	W
Power Dissipation i	TO252-3	Pui	1 *1	VV
Power Dissipation 2	TO220CP-3	Pd2	22 *2	W
Power Dissipation 2	TO252-3	Fu2	10 ^{*2}	VV
Output Current	BA78□□	lo	1 *3	۸
Output Current	BA78□□M	10	0.5 *3	Α
Operating Temperature Range		Topr	-40~+85	°C
Storage Temperature	Range	Tstg	-55~+150	°C
Operating Junction Te	emperature Range	Tj	-40 ~ +150	°C

●Operating Conditions(Ta=25°C, Pd should not be exceeded) BA78□□CP/FP

	omotor	Cumbal	Min	Max	Lloit
Para	ameter	Symbol	Min.	Max.	Unit.
	BA7805		7.5	25	
	BA7806		8.5	21	
	BA7807		9.5	22	
	BA7808		10.5	23	
Innut	BA7809		11.5	26	V
Input Voltage	BA7810	Vin	12.5	25	
voltage	BA7812		14.5	27	
	BA7815		17.5	30	
	BA7818		21	33	
	BA7820		23	33	
	BA7824		27	33	
Output C	Output Current		-	1	Α

BA78M□□CP/FP

Par	ameter	Symbol	Min.	Max.	Unit.	
	BA78M05		7.5	25		
	BA78M06		8.5	21		
	BA78M07		9.5	22		
	BA78M08		10.5	23		
loout	BA78M09		11.5	26		
Input Voltage	BA78M10	Vin	12.5	25	V	
vollage	BA78M12		14.5	27		
	BA78M15		17.5	30		
	BA78M18		21	33		
	BA78M20		23	33		
	BA78M24		27	33		
Output C	Output Current		-	0.5	Α	

^{*1} Derating in done 16mW/°C(TO220CP-3), 8mW/°C(TO252-3) for temperatures above Ta=25°C
*2 Derating in done 176mW/°C(TO220CP-3), 80mW/°C(TO252-3) for temperatures above Ta=25°C, Mounted on infinity Alminium heat sink.

^{*3} Pd,ASO and Tjmax(150°C) should not be exceeded.

● Electrical Characteristics BA78M□□CP/FP

 $(Ta=25^{\circ}C, Vin=10V(05), 11V(06), 13V(07), 14V(08), 15V(09), 16V(10), 19V(12), 23V(15), 27V(18), 29V(20), 33V(24), \ lo=350 mA \ unless \ otherwise \ specified)$

		8),15V(09),16V(10),19V(12),23\ 		Limit					
Parameter	Symbol	Туре	Min	Тур	Max	Unit	Condition		
		05	4.8	5.0	5.2				
		06	5.75	6.0	6.25				
		07	6.7	7.0	7.3				
		08	7.7	8.0	8.3				
		09	8.6	9.0	9.4				
Output Voltage 1	Vo1	10	9.6	10.0	10.4	V	Io=350mA		
, ,		12	11.5	12.0	12.5	1			
		15	14.4	15.0	15.6				
		18	17.3	18.0	18.7				
		20	19.2	20.0	20.8				
		24	23.0	24.0	25.0				
		05	4.75	-	5.25		Vin=7.5~20V, Io=5mA~350mA		
		06	5.7	-	6.3		Vin=8.5~21V, Io=5mA~350mA		
		07	6.65	-	7.35		Vin=9.5~22V, Io=5mA~350mA		
		08	7.6	-	8.4		Vin=10.5~23V, Io=5mA~350mA		
		09	8.55	-	9.45		Vin=11.5~24V, Io=5mA~350mA		
Output Voltage 2	Vo2	10	9.5	-	10.5	V	Vin=12.5~25V, Io=5mA~350mA		
		12	11.4	-	12.6		Vin=15~27V, Io=5mA~350mA		
		15	14.25	-	15.75		Vin=17.5~30V, Io=5mA~350mA		
		18	17.1	-	18.9		Vin=21~33V, Io=5mA~350mA		
		20	19.0	-	21.0		Vin=23~33V, Io=5mA~350mA		
		24	22.8	-	25.2		Vin=27~33V, Io=5mA~350mA		
		05	-	3	100		Vin=7~25V, Io=200mA		
		06	-	3	100		Vin=8~25V, Io=200mA		
		07	-	4	100		Vin=9~25V, Io=200mA		
		08	-	4	100		Vin=10.5~25V, Io=200mA		
		09	-	4	100		Vin=11.5~26V, Io=200mA		
Line Regulation 1	Reg.I1	10	-	5	100	mV	Vin=12.5~28V, Io=200mA		
		12	-	5	100		Vin=14.5~30V, Io=200mA		
		15	-	6	100		Vin=17.5~30V, Io=200mA		
		18	-	7	100		Vin=21~33V, Io=200mA		
		20	-	8	100		Vin=23~33V, Io=200mA		
		24	-	10	100		Vin=27~33V, Io=200mA		
		05	-	1	50		Vin=8~12V, Io=200mA		
		06	-	1	50		Vin=9~25V, Io=200mA		
		07	-	1	50		Vin=10~25V, Io=200mA		
		08	-	1	50		Vin=11~25V, Io=200mA		
		09	-	2	50		Vin=12~25V, Io=200mA		
Line Regulation 2	Reg.I2	10	-	2	50	mV	Vin=14~26V, Io=200mA		
		12	-	3	50		Vin=16~30V, Io=200mA		
		15	-	3	50		Vin=20~30V, Io=200mA		
		18	-	3	50		Vin=24~33V, Io=200mA		
		20	-	4	50		Vin=24~33V, Io=200mA		
		24	-	5	50		Vin=28~33V, Io=200mA		
		05	62	78	-				
		06	60	74	-				
		07	57	71	-				
		08	56	69	-				
		09	56	67	-				
Ripple Rejection	R.R.	10	56	66	-	dB	ein=1Vrms, f=120Hz, Io=100mA		
		12	55	63	-				
		15	54	60	-				
		18	53	58	-]			
		20	53	58	_				
		24	50	55	-	<u> </u>			
Ta an a made ::::		05	-	-1.0	-				
Temperature	T	06/07/08/09/10/12	-	-0.5	-	~\\/\°	In FmA Ti 0 405°0		
Coefficient of	Tcvo	15/18	-	-0.6	-	mV/°C	lo=5mA, Tj=0~125°C		
Output Voltage		20/24	-	-0.7	-	1			
Peak Output Current	Іо-р	common	-	875	-	mA	Tj=25°C		
· car carpar carrors									

● Electrical Characteristics BA78M□□CP/FP

 $(Ta=25^{\circ}\text{C}, Vin=10\text{V}(05), 11\text{V}(06), 13\text{V}(07), 14\text{V}(08), 15\text{V}(09), 16\text{V}(10), 19\text{V}(12), 23\text{V}(15), 27\text{V}(18), 29\text{V}(20), 33\text{V}(24), lo=350\text{mA} \text{ unless otherwise specified})$

Parameter	Symbol	Туре	Min	Limit Typ	Max	Unit	Condition
		05	-	20	100		
		06	-	20	120		
		07	-	20	140		
		08	-	20	160		
		09	-	20	180		
Load Regulation 1	Reg.L1	10	_	20	200	mV	Io=5mA~500mA
		12	-	20	240		
		15	-	20	300		
		18	_	20	360		
		20	_	20	400		
		24	_	20	480		
		05	-	10	50		
		06	_	10	60		
		07	_	10	70		
		08	-	10	80		
		09	-	10	90		
Load Regulation 2	Reg.L2	10	-	10	100	mV	lo=5mA~200mA
Loau Negulation Z	IN e g.∟∠	12	-	10	120	IIIV	IO-JIIA - ZUUIIA
		15	-	10	150		
		18	-	10	180		
		20	-	10	200		
		24	†	10	240		
			-				+
		05 06	-	40	-		
			-	60	-		
		07	-	70	-		
		08	-	80	-		
Output Noise	.,	09	-	90	-		
Voltage	Vn	10	-	100	-	μV	f=10Hz~100kHz
•		12	-	110	-		
		15	-	130	-		
		18	-	140	-		
		20	-	150	-		
		24	-	170	-		
Bias Current	lb	common	-	4.5	6.0	mA	Io=0mA
Bias Current Change1	lb1	common	-	-	0.5	mA	lo=5mA~350mA
		05	-	-	0.8		Vin:8~25V, Io=200mA
		06	-	-	0.8		Vin:9~25V, Io=200mA
		07	-	-	0.8		Vin:10~25V, Io=200mA
		08	-	-	0.8		Vin:10.5~25V, Io=200mA
		09	-	-	0.8		Vin:12~25V, Io=200mA
Bias Current Change 2	lb2	10	-	-	8.0	mA	Vin:13~25V, Io=200mA
		12	-	-	8.0		Vin:14.5~30V, Io=200mA
		15	-	-	8.0		Vin:17.5~30V, Io=200mA
		18	-	-	0.8		Vin:21~33V, Io=200mA
		20	-	-	0.8		Vin:23~33V, Io=200mA
	<u></u>	24	-	-	0.8		Vin:27~33V, Io=200mA
Short-Circuit	loc	05/06/07/08	-	0.4	-	Λ	Vin=25V
Output Current	los	09/10/12/15/18/20/24	-	0.17	_	Α	Vin=30V
		05	-	9	-		
		06	-	10	-		
		07	-	11	-		
		08	-	12	-		
		09	-	13	-		
Output Resistance	Ro	10	-	14	-	mΩ	f=1kHz
		12	-	16	-		
		15	-	19	-		
		1:0					
			-	1	-		
		18		22 25			

● Electrical Characteristics BA78□□CP/FP

 $(Ta=25^{\circ}\text{C}, Vin=10\text{V}(05), 11\text{V}(06), 13\text{V}(07), 14\text{V}(08), 15\text{V}(09), 16\text{V}(10), 19\text{V}(12), 23\text{V}(15), 27\text{V}(18), 29\text{V}(20), 33\text{V}(24), lo=500\text{mA unless otherwise specified})$

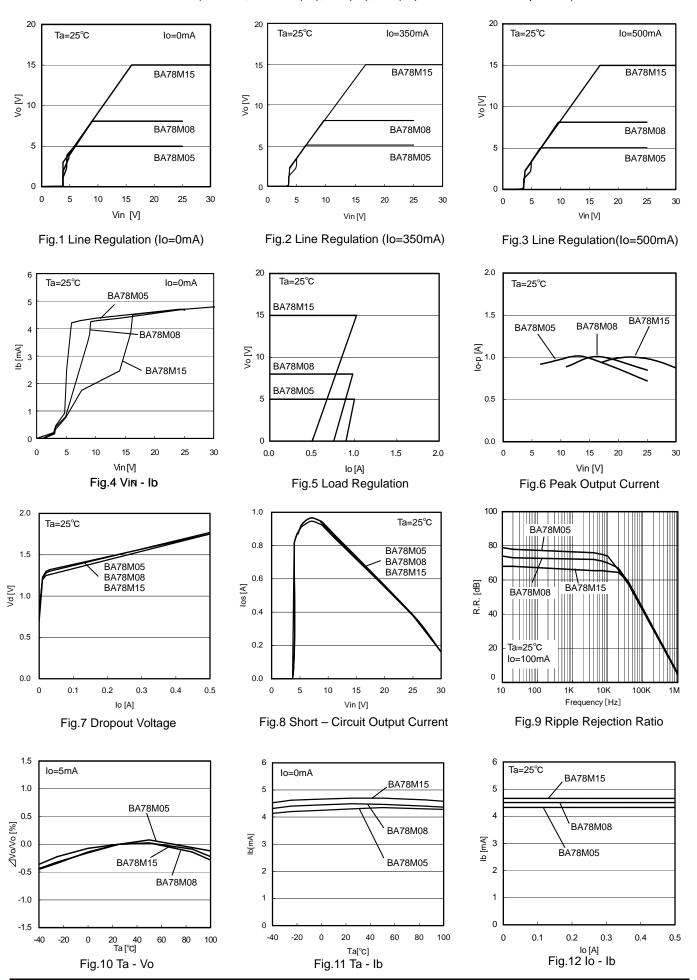
Parameter	Symbol	Type		Limit	1	Unit	Condition
	-,		Min	Тур	Max		
		05 06	4.8 5.75	5.0	5.2 6.25		
		06	6.7	6.0 7.0	7.3		
		08	7.7	8.0	8.3		
		09	8.6	9.0	9.4		
Output Voltage 1	Vo1	10	9.6	10.0	10.4	V	Io=500mA
		12	11.5	12.0	12.5		
		15	14.4	15.0	15.6		
		18	17.3	18.0	18.7		
		20	19.2	20.0	20.8		
		24	23.0	24.0	25.0		
		05	4.75	-	5.25		Vin=7.5~20V, Io=5mA~1A
		06	5.7	-	6.3		Vin=8.5~21V, Io=5mA~1A
		07	6.65	-	7.35		Vin=9.5~22V, Io=5mA~1A
		08	7.6	-	8.4		Vin=10.5~23V, Io=5mA~1A
Output Valtage 2	1/02	09	8.55	-	9.45	V	Vin=11.5~26V, lo=5mA~1A
Output Voltage 2	Vo2	10	9.5 11.4	-	10.5 12.6	V	Vin=12.5~25V, Io=5mA~1A Vin=15~27V, Io=5mA~1A
		15	14.25	-	15.75		Vin=15~27 V, 10=5IIIA~ 1A Vin=17.5~30V, 10=5mA~1A
		18	17.1	-	18.9		Vin=21~33V, lo=5mA~1A
		20	19.0	-	21.0		Vin=23~33V, Io=5mA~1A
		24	22.8	-	25.2		Vin=27~33V, Io=5mA~1A
		05	-	3	100		Vin=7~25V, Io=500mA
		06	-	4	120		Vin=8~25V, Io=500mA
Line Regulation 1		07	-	5	140		Vin=9~25V, Io=500mA
		08	-	5	160		Vin=10.5~25V, Io=500mA
		09	-	6	180		Vin=11.5~26V, Io=500mA
	Reg.I1	10	-	7	200	mV	Vin=12.5~27V, Io=500mA
		12	-	8	240		Vin=14.5~30V, Io=500mA
		15	-	9	300		Vin=17.5~30V, Io=500mA
		18	-	10	360		Vin=21~33V, Io=500mA
		20 24	-	12 15	400		Vin=23~33V, Io=500mA
		05	-	1	480 50		Vin=27~33V, Io=500mA Vin=8~12V, Io=500mA
		06	-	2	60	1	Vin=9~13V, Io=500mA
		07	_	2	70		Vin=10~15V, Io=500mA
		08	_	3	80		Vin=11~17V, Io=500mA
		09	-	4	90		Vin=13~19V, Io=500mA
Line Regulation 2	Reg.I2	10	-	4	100	mV	Vin=14~20V, Io=500mA
ŭ		12	-	5	120		Vin=16~22V, Io=500mA
		15	-	5	150		Vin=20~26V, Io=500mA
		18	-	5	180		Vin=24~30V, Io=500mA
		20	-	7	200		Vin=26~32V, Io=500mA
		24	-	10	240		Vin=30~33V, Io=500mA
		05	62	78	-		
		06	59	73	-		
		07	57	69	-		
		08	56	65	-		
Dinnlo Deigotion	D D	09	56 55	64	-	40	ein=1Vrms, f=120Hz,
Ripple Rejection	R.R.	10 12	55 55	64 63	-	dB	lo=100mA
		15	55	62	-		
		18	53	61	-		
		20	53	60	-		
		24	50	58	-		
		05	-	-1.0	-		
Temperature	_	06/07/08/09/10/12	-	-0.5	-		Ti o
Coefficient of	Tcvo	15/18	-	-0.6	-	mV/°C	lo=5mA, Tj=0~125°C
Output Voltage		20/24	-	-0.7	-]	
Peak Output Current	Іо-р	common	-	1.7	-	Α	Tj=25°C
Dropout Voltage	Vd	common	-	2.0	-	V	Io=1A
							· · · · · · · · · · · · · · · · · · ·

● Electrical Characteristics BA78□□CP/FP

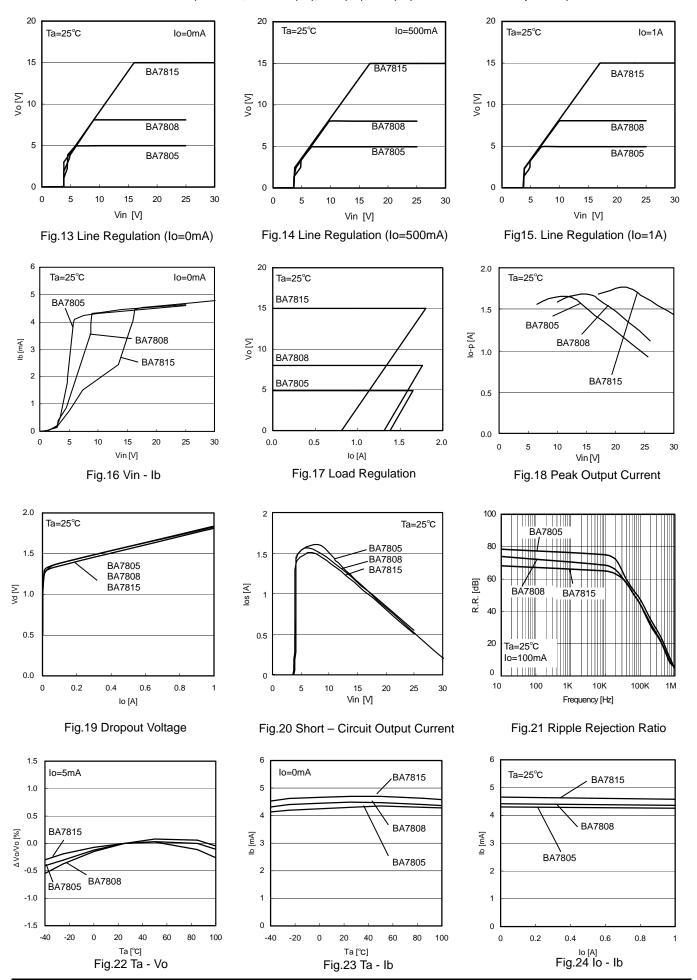
 $(Ta=25^{\circ}C, Vin=10V(05), 11V(06), 13V(07), 14V(08), 15V(09), 16V(10), 19V(12), 23V(15), 27V(18), 29V(20), 33V(24), Io=500mA \quad unless otherwise specified)$

(1a=25 C, VIII=10 V (05), 11 V (T	1V(08),15V(09),16V(10),19V(12 	1,23 (13),21	Limit	20),33 V (24),10=300IIIA	unless otherwise specified)	
Parameter	Symbol	Туре	Min	Тур	Max	Unit	Condition	
		05	-	15p	100			
		06		16	120			
			-					
		07	-	17	140	_		
		08	-	19	160	_		
		09	-	20	180	_		
Load Regulation 1	Reg.L1	10	-	21	200	mV	Io=5mA~1A	
		12	-	23	200			
		15	-	27	300			
		18	-	30	360			
		20	-	32	400			
		24	-	37	480			
		05	-	5	50			
		06	-	6	60	-		
		07	_	6	70	-		
		08	-	7		-		
					80	4		
		09	-	8	90	.,		
Load Regulation 2	Reg.L2	10	-	8	90	mV	Io=250mA~750mA	
		12	-	10	100			
		15	-	10	150			
		18	-	12	180			
		20	-	14	200			
		24	-	15	240			
		05	-	40	-			
		06	-	60	-	1		
		07	-	70	-			
		08	-	80	_	-		
						-		
Output Noise		09	-	90	-	.,		
Voltage	Vn	10	-	100	-	μV	f=10Hz~100kHz	
· ·		12	-	110	-	_		
		15	-	125	-			
		18	-	140	-			
		20	-	150	-			
		24	-	180	-			
Bias Current	lb	common	-	4.5	8.0	mA	Io=0mA	
Bias Current Change 1	lb1	common	-	-	0.5	mA	Io=5mA~1A	
•		05	-	-	0.8		Vin:8~25V, Io=500mA	
		06	-	-	0.8		Vin:8.5~25V, Io=500mA	
		07	_	_	0.8	-	Vin:9.5~25V, Io=500mA	
		08	_	_	0.8	-	Vin:10.5~25V, Io=500mA	
						_		
D' O Ob O	11.0	09	-	-	0.8		Vin:11.5~26V, Io=500mA	
Bias Current Change 2	lb2	10	-	-	0.8	mA	Vin:12.5~27V, Io=500mA	
		12	-	-	0.8	_	Vin:14.5~30V, Io=500mA	
		15	-	-	0.8		Vin:17.5~30V, Io=500mA	
		18	-	-	0.8		Vin:21~33V, Io=500mA	
		20	-	-	0.8		Vin:23~33V, Io=500mA	
		24	-	-	0.8		Vin:27~33V, Io=500mA	
Short-Circuit	1	05/06/07/08	-	0.6	-		Vin=25V	
Output Current	los	09/10/12/15/18/20/24	-	0.3	-	Α	Vin=30V	
		05	-	9	-			
		06		10	-	1		
		07		10	-	1		
						-		
		08		10	-	4		
	_	09	-	10	-			
Output Resistance	Ro	10	-	11	-	mΩ	f=1kHz	
	KO	12	-	12	-			
						=		
		15	-	14	-			
			-	14 17	-			
		15				-		

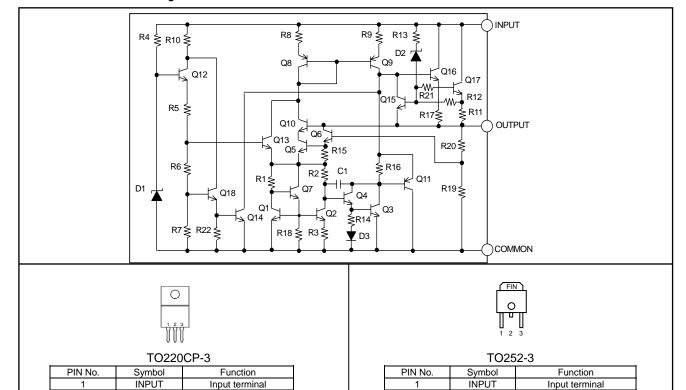
●BA78M□□ Characteristics data(Ta=25°C, Vin=10V(05), 14V(08), 23V(15) unless otherwise specified)



●BA78□□ Characteristics data (Ta=25°C, Vin=10V(05), 14V(08), 23V(15) unless otherwise specified)



Internal Circuit Structural Diagram



2

3

N.C.

OUTPUT

COMMON

●Protection Circuit

(1)Over-current protection circuit

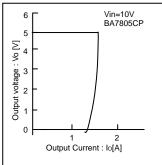
COMMON

OUTPUT

When the maximum rating current or more is rushed, it controls the current ability and protects the IC from destruction.

Ground terminal

Output terminal



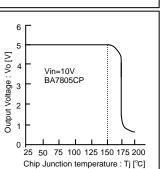
Non connection terminal

Output terminal

Ground terminal

(2) Thermal shutdown circuit

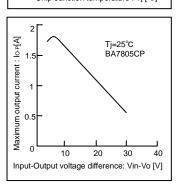
When the chip temperature of IC exceeds the setting temperature, the IC goes OFF, and it controls the IC not to be destroyed by the heat generation. It can be restored by being lowered the chip temperature of IC below the setting temperature.



(3) Safety operation area control circuit

It controls the output current in inverse proportion ratio to voltage difference (input-output).

When voltage difference becomes bigger, the IC will be destroyed in rush current. It protects the IC by controlling the current ability according to the voltage level.



Thermal design

Refer to the following thermal derating curves (Fig. 25, 26), when using in the status of Ta=25°C or more.

The characteristic of IC is greatly related to the operating temperature.

When it is used in over maximum junction temperature, the elements inside IC might become weaker and be destroyed. It is recommended to take into consideration thermal of IC.

Note that the temperatures are in the allowed temperature limits and operated within Pd.

It is necessary to operate it at junction temperature Tjmax or less to prevent IC from the thermal destruction.

Please operate IC within permissible loss Pd because the junction temperature Tj might become considerably a high temperature even if ambient temperature Ta is normal temperature (25°C).

Power consumption Pc(W) may be expressed by the equation shown below:

Pc=(Vin-Vo) × Io+ Vin × I b permissible loss Pd≧Pc

 $lo \le \frac{Pd - Vin \times lk}{Vin - Vo}$

Vin : Input Voltage
Vo : Output Voltage
Io : Output Current
Ib : Bias current

Maximum Output current lo_{MAX} can be calculated in thermal design.

· Calculation example

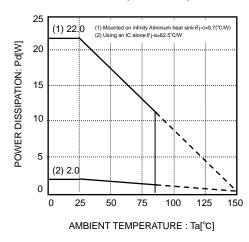
Ex.1) Ta=85°C, Vin =7.5V, Vo=5.0V

$$lo \le \frac{1.04 - 7.5 \times 4.5m}{7.5 - 5.0}$$

$$lo \le 400mA$$

Using TO220CP-3 alone θ ja=62.5°C/W \rightarrow 16mW/°C Pd=1.04W at 85°C

Be sure to use this IC within a power dissipation at the range of operating temperature.



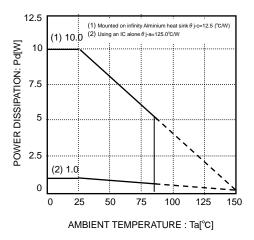


Fig.25 Thermal derating curve (TO220CP-3)

Fig.26 Thermal derating curve (TO252-3)

Terminal Setting and Cautions

INPUT

It is recommended that a capacitor (about 0.33uF) be inserted between INPUT and COMMON. The value of capacitor is designed suitable for the actual application.

OUTPUT

It is recommended that a capacitor (about 0.1uF) be inserted between OUTPUT and COMMON.

A tantalum capacitor can also be used for this pin because insufficient capacitors may cause oscillation by a temperature change.

COMMON

Keep the no voltage drop between Ground level of set board and IC.

When there is the voltage difference, setting voltage becomes inaccuracy and unstable.

It is recommended to connect by wide, short pattern, and lower the inpedance.

Notes for use

(1) Absolute Maximum Ratings

While utmost care is taken to quality control of this product, any application that may exceed some of the absolute maximum ratings including the voltage applied and the operating temperature range may result in breakage. If broken, short-mode or open-mode may not be identified. So if it is expected to encounter with special mode that may exceed the absolute maximum ratings, it is requested to take necessary safety measures physically including insertion of fuses.

(2) Ground voltage

Make setting of the potential of the GND terminal so that it will be maintained at the minimum in any operating state. Furthermore, check to be sure no terminals are at a potential lower than the GND voltage including an actual electric transient.

(3) Thermal design

When you do the kind of use which exceeds Pd, It may be happened to deteriorating IC original quality such as decrease of electric current ability with chip temperature rise. Do not exceed the power dissipation (Pd) of the package specification rating under actual operation, and please design enough temperature margins.

(4) Short-circuiting between terminals, and mismounting

When mounting to pc board, care must be taken to avoid mistake in its orientation and alignment. Failure to do so may result in IC breakdown. Short-circuiting due to foreign matters entered between output terminals, or between output and power supply or GND may also cause breakdown.

(5) Operation in Strong electromagnetic field

Be noted that using the IC in the strong electromagnetic radiation can cause operation failures.

(6) Inspection with the IC set to a pc board

If a capacitor must be connected to the pin of lower impedance during inspection with the IC set to a pc board, the capacitor must be discharged after each process to avoid stress to the IC. For electrostatic protection, provide proper grounding to assembling processes with special care taken in handling and storage. When connecting to jigs in the inspection process, be sure to turn OFF the power supply before it is connected and removed.

(7) Input to IC terminals

This is a monolithic IC with P⁺ isolation between P-substrate and each element as illustrated below. This P-layer and the N-layer of each element form a P-N junction, and various parasitic element are formed.

If a resistor is joined to a transistor terminal as shown in Fig 28.

OP-N junction works as a parasitic diode if the following relationship is satisfied;

GND>Terminal A (at resistor side), or GND>Terminal B (at transistor side); and

Oif GND>Terminal B (at NPN transistor side),

a parasitic NPN transistor is activated by N-layer of other element adjacent to the above-mentioned parasitic diode. The structure of the IC inevitably forms parasitic elements, the activation of which may cause interference among circuits, and/or malfunctions contributing to breakdown. It is therefore requested to take care not to use the device in such manner that the voltage lower than GND (at P-substrate) may be applied to the input terminal, which may result in activation of parasitic elements.

(8) Ground wiring pattern

If small-signal GND and large-current GND are provided, It will be recommended to separate the large-current GND pattern from the small-signal GND pattern and establish a single ground at the reference point of the set PCB so that resistance to the wiring pattern and voltage fluctuations due to a large current will cause no fluctuations in voltages of the small-signal GND. Pay attention not to cause fluctuations in the GND wiring pattern of external parts as well.

(9) Thermal shutdown circuit

A temperature control circuit is built in the IC to prevent the damage due to overheat. Therefore, the output is turned off when the thermal circuit works and is turned on when the temperature goes down to the specified level.

But, built-in the IC a temperature control circuit to protect itself, and avoid the design used the thermal protection.

(10) Over current protection circuit

The over-current protection circuits are built in at output, according to their respective current outputs and prevent the IC from being damaged when the load is short-circuited or over-current. But, these protection circuits are effective for preventing destruction by unexpected accident. When it's in continuous protection circuit moving period don't use please. And for ability, because this chip has minus characteristic, be careful for heat plan.

(11) There is a possibility to damage an internal circuit or the element when Vin and the voltage of each terminal reverse in the application. For instance, Vin is short-circuited to GND etc. with the charge charged to an external capacitor. Please use the capacitor of the output terminal with 1000µF or less. Moreover, the Vin series is recommended to insert the diode of the by-pass the diode of the backflow prevention or between each terminal and Vin.

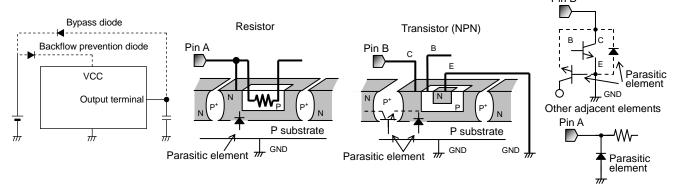
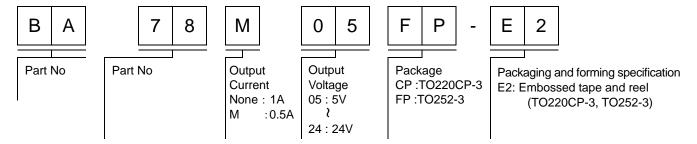


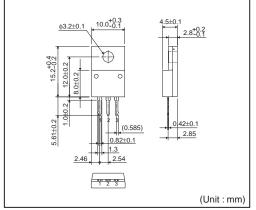
Fig.27 Bypass Diode

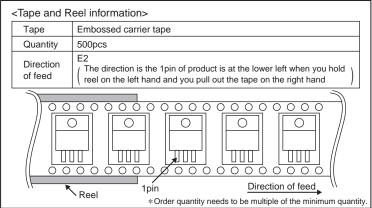
Fig.28 Simplified structure of monorisic IC

Ordering part number

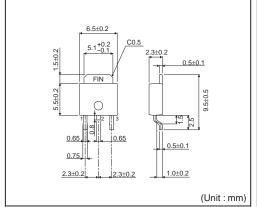


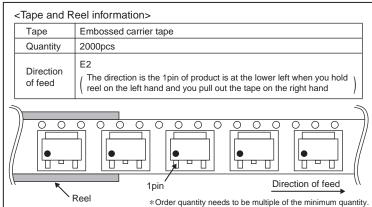
TO220CP-3





TO252-3





Notice

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JAPAN	USA	EU	CHINA	
CLASSⅢ	CLASSⅢ	CLASS II b	CL ACCTI	
CLASSIV	CLASSIII	CLASSⅢ	CLASSII	

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 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

QR code printed on ROHM Products label is for ROHM's internal use only.

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Since our Products might fall under controlled goods prescribed by the applicable foreign exchange and foreign trade act, please consult with ROHM representative in case of export.

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